#### **STW78N65M5**



# Automotive-grade N-channel 650 V, 0.024 Ω typ., 69 A, MDmesh™ V Power MOSFET in a TO-247 package

Datasheet - production data

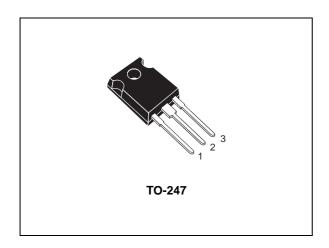
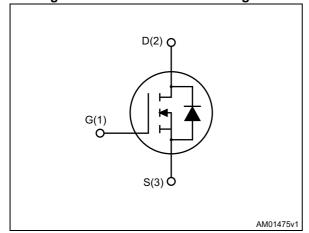


Figure 1. Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub> @T <sub>jmax.</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STW78N65M5	710 V	$0.032\Omega$	69 A

- Designed for automotive applications and AEC-Q101 qualified
- Higher V<sub>DSS</sub> rating
- Higher dv/dt capability
- · Excellent switching performance
- · Easy to drive
- 100% avalanche tested

#### **Applications**

· Switching applications

#### **Description**

This device is an N-channel MDmesh™ V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

**Table 1. Device summary** 

Order code	Marking	Package	Packaging
STW78N65M5 78N65M5		TO-247	Tube

Contents STW78N65M5

## **Contents**

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STW78N65M5 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate- source voltage	±25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	69	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	41.5	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	276	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	450	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
T <sub>j</sub>	Max. operating junction temperature	150	°C

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.28	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	50	°C/W

**Table 4. Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Max current during repetitive or single pulse avalanche (pulse width limited by $T_{\text{JMAX}}$ )	15	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	2000	mJ

<sup>2.</sup>  $I_{SD} \leq 69 \text{ A}, \text{ di/dt} = 400 \text{ A/}\mu\text{s}, \text{ V}_{DS \text{ peak}} < \text{V}_{(BR)DSS}, \text{V}_{DD} = 400 \text{ V}$ 

 $<sup>3. \</sup>quad V_{DS} \leq 520 \ V$ 

Electrical characteristics STW78N65M5

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 1 mA	650			V
I <sub>DSS</sub>	_	V <sub>DS</sub> = 650 V V <sub>DS</sub> = 650 V, T <sub>C</sub> =125 °C			1 100	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 25 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 34.5 A		0.024	0.032	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	9000	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	210	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$	-	9	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	768	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	205	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.5	ı	Ω
Qg	Total gate charge	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 34.5 A,	-	203	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	50	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 16)	-	84	-	nC

<sup>1.</sup>  $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

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<sup>2.</sup>  $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(V)</sub>	Voltage delay time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 40 A,	-	163	-	ns
t <sub>r(V)</sub>	Voltage rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	14	-	ns
t <sub>f(i)</sub>	Current fall time	(see Figure 17)	-	14	-	ns
t <sub>c(off)</sub>	Crossing time	(see <i>Figure 20</i> )	-	26	-	ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		69	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		276	Α
V <sub>SD</sub> (2)	Forward on voltage	I <sub>SD</sub> = 69 A, V <sub>GS</sub> = 0	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 69 A,	-	504		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/µs	-	13		μC
I <sub>RRM</sub>	Reverse recovery current	V <sub>DD</sub> = 100 V (see <i>Figure 17</i> )	-	49		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 69 A,	-	635		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/µs V <sub>DD</sub> = 100 V, T <sub>i</sub> = 150 °C	-	19		μC
I <sub>RRM</sub>	Reverse recovery current	(see <i>Figure 17</i> )	-	59		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration =  $300 \mu s$ , duty cycle 1.5%

Electrical characteristics STW78N65M5

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

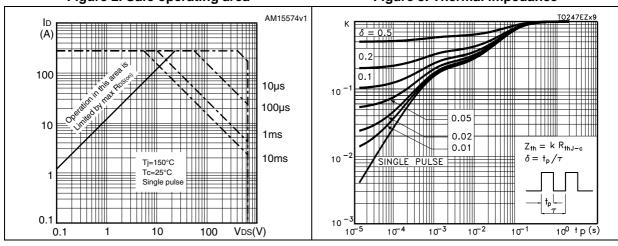


Figure 4. Output characteristics

Figure 5. Transfer characteristics

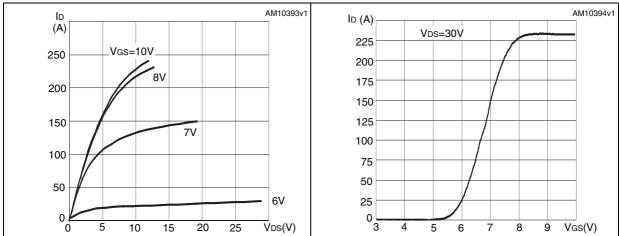
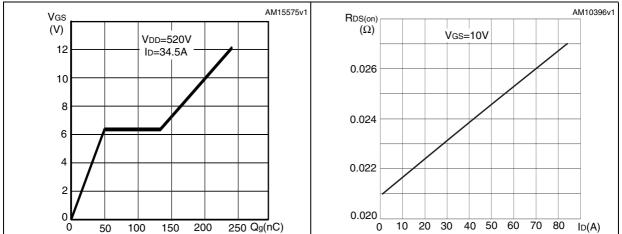


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



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0.1

Figure 8. Capacitance variations

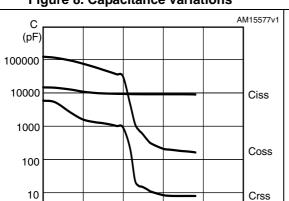


Figure 9. Output capacitance stored energy

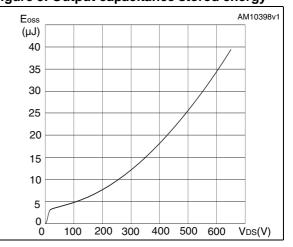


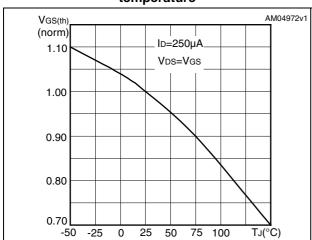
Figure 10. Normalized gate threshold voltage vs temperature

10

100

1000 VDS(V)

Figure 11. Normalized on-resistance vs temperature



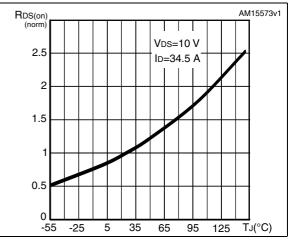
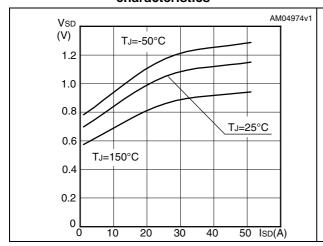
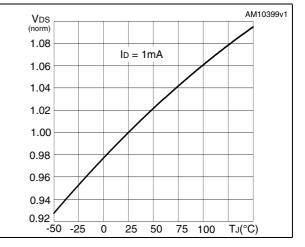


Figure 12. Source-drain diode forward characteristics

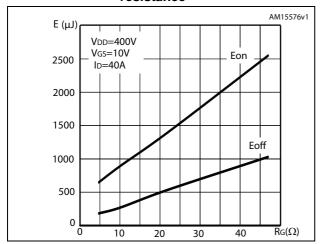
Figure 13. Normalized  $V_{DS}$  vs temperature





Electrical characteristics STW78N65M5

Figure 14. Switching losses vs gate resistance <sup>(1)</sup>



1. Eon including reverse recovery of a SiC diode

STW78N65M5 Test circuits

### 3 Test circuits

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

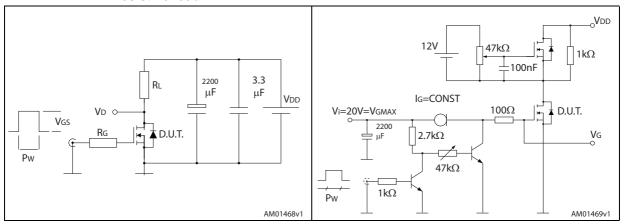


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped inductive load test circuit

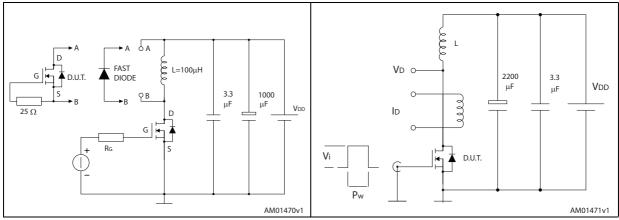
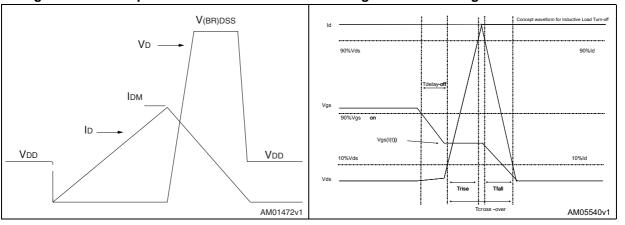


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform



# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.



Table 9. TO-247 mechanical data

		mm.	
Dim.	Min.	Тур.	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70



HEAT-SINK PLANE

BACK VIEW 0075325, G

Figure 21. TO-247 drawing

STW78N65M5 Revision history

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
16-Jul-2012	1	First release.
22-Jan-2013	2	Modified: R <sub>DS(on)</sub> on first page, I <sub>D</sub> , I <sub>DM</sub> on <i>Table 2</i> , note 2 on <i>Table 2</i> , typical values on <i>Table 6</i> , 7, max and typical values on <i>Table 8</i> , <i>Figure 2</i> , 6, 8, 9, 11 and 14
07-Aug-2013	3	<ul> <li>Minor text changes</li> <li>Modified: Applications in first page</li> <li>Added: MOSFET dv/dt ruggedness parameter in Table 2</li> <li>Added: Table 4: Avalanche characteristics</li> <li>Modified: Figure 15, 16, 17 and 18</li> </ul>
08-Aug-2013	4	<ul><li>– Minor text changes</li><li>– Modified: Figure 14</li></ul>

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